

Product Version: V3

About this document

Scope and purpose

This document specifies the Release Notes for OPTIGA™ Trust M solution.

Intended audience

This document addresses the audience: customers, solution providers and system integrators.

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Revision History

Page	Subjects (major changes since last revision)	
5	Engineering Sample Release of OPTIGA™ Trust M v3.00.2484 and its corresponding host	
	libraries.	

Product Version Overview



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1.1 **Release versions**

The Release versions defined in the below table is the overall version of OPTIGA™ Trust M which includes the OPTIGA™ Trust M Host library package and OPTIGA™ Trust M security chip version.

Release Version	Build Date	Description
v3.00.2484	2020-09-17	Engineering Sample Release of OPTIGA™ Trust M and its corresponding host libraries

Versioning Scheme 1.2

1. Product Version:

It defines the version of the product. (Example: OPTIGA Trust M V1, V2, V3 etc...)

2. Release version:

Defines the revision of the product released with encoding scheme Major, Minor, and Build number. **Example** – v3.00.2484 (Major version : 3, Minor version : 00, Build version : 2484)

- 2.1. Major version It depicts the major changes/revisions of the product. Early engineering sample releases will always have the release major version as zero. (Example - vx.yy.zzzz)
- 2.2. Minor version It changes with releases or/and significant changes in the product. (Example vx.**yy**.zzzz)
- 2.3. **Build version** It increments based on each change/release of the product. (Example vx.yy.zzzz)

Note: Every release will have an OPTIGA[™] security chip version [5], which defines the version of the software loaded on the OPTIGA™ security chip.

OPTIGA™ Trust M security chip version will have the same major and minor version numbers of that particular release version. But the build number of OPTIGA™ Trust M security chip version might be different from the overall release version.

Example:

Release Version : v3.00.2484 (Major version: 3, Minor version: 00, Build version: 2484) Security chip version : v3.00.2440 (Major version: 3, Minor version: 00, Build version: 2440)

Engineering Sample Release v3.00.2484



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2.1 **Product Description**

OPTIGA™ Trust M v3.00.2484 is an Embedded Security Solution covering use cases to protect the authenticity, integrity and confidentiality of your device: mutual authentication, secure communication, data storage protection, cryptographic toolbox functionalities and lifecycle management for connected devices.

2.2 Scope of Release

OPTIGA™ Trust M v3.00. 2484 is released as Engineering Sample Release. The Product is qualified by Infineon with complete documentation describing all features as stated below.

2.3 **Contents of the Evaluation Kit**

- 1. OPTIGA™ Trust M security chip with software build v3.00.2440
- 2. Package containing following Software and Documentation
 - 2.1. binaries
 - 2.1.1. Examples for XMC4800 IOT Connectivity kit
 - 2.2. certificates
 - 2.2.1. Contains Infineon Test CA certificate for execution of use cases
 - 2.3. documents
 - 2.3.1.OPTIGA™ Trust M Datasheet v3.00
 - 2.3.2.Infineon I2C Protocol v2.02
 - 2.3.3.OPTIGA™ Trust M Solution Reference Manual v3.00
 - 2.3.4.OPTIGA™ Trust M Release Notes v3.00
 - 2.3.5.OPTIGA™ Trust M Keys And Certificates v3.00
 - 2.3.6.OPTIGA™ Trust M Host Library Documentation
 - 2.3.7.OPTIGA™ Trust M Getting Started Guide v3.00
 - 2.3.8.OPTIGA™ Trust M License Information
 - 2.4. examples
 - 2.4.1.optiga
 - 2.4.1.1. Example files for OPTIGA™ host library APIs
 - 2.4.2.tools

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- 2.4.2.1. Tool to generate protected update data set for the data objects, key set for key objects and metadata set for data/key objects (used for optiga_util_protected_update API example).
- 2.5. externals
 - 2.5.1. Directory for 3rd party libraries (e.g. mbed TLS)
- 2.6. optiga
 - 2.6.1.OPTIGA™ host library with source and header files
- 2.7. pal
 - 2.7.1. Platform specific implementation for XMC4800 IoT Connectivity Kit
- 2.8. projects
 - 2.8.1. DAVE™ Eclipse project for XMC4800 IoT Connectivity Kit
- 3. Hardware
 - 3.1. XMC4800 IoT Connectivity Kit
 - 3.2. Shield2Go with OPTIGA™ Trust M security chip
 - 3.3. My IoT Adapter
- 4. Open Source Software subject to separate licensing terms as below
 - 4.1. Applicable for XMC4800 IoT Connectivity Kit
 - 4.1.1.mbed TLS v2.16.0 crypto library (https://tls.mbed.org/download)
 - 4.1.2.LUFA USB stack (https://www.lufa-lib.org)

2.4 Features

- 1. OPTIGA™ Trust M Security Chip Software
 - a. Infineon I2C protocol v2.02 based communication with Shielded Connection support.
 - b. Configurable protected data storage.
 - c. Life cycle management.
 - d. Crypto ToolBox commands with
 - i. ECC NIST P256/P384/P521, Brainpool P256/384/512, SHA-256/384/512 (sign, verify, key generation, ECDH, key derivation)
 - ii. RSA 1024/2048 (Sign, Verify, Key generation, Encrypt, Decrypt, Pre-master secret generation for RSA Key exchange (reference TLS V1.2))
 - iii. Symmetric encryption and decryption using AES-128/192/256 (ECB, CBC, CBC-MAC, CMAC) and HMAC SHA256/384/512.
 - iv. KeyDerivation using HKDF SHA256/384/512
 - e. Hibernate and restore support.
 - f. Integrity and confidentiality protected update of data, metadata and key objects
 - g. Boot phase flag(Global and Application security states) based access to protected keys and data

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- h. HMAC verification with authorization reference states.
- Configurable security monitor.
- 2. OPTIGA™ Trust M Host Software
 - a. Support for XMC4800 IoT Connectivity Kit added.
 - b. DAVE Eclipse project added to release package. This project can be used for compilation and debugging.
 - Optiga Crypt Library (Crypto Toolbox command APIs)
 - d. Optiga Util Library (Open/Close Application, Read/Write and Protected Update command
 - e. Infineon I2C protocol v2.02 based communication with Shielded Connection support.
 - Tool to generate CBOR based manifest and payload fragments for optiga_util_protected_update API example.

2.5 **Fixes**

None

2.6 **Enhancements**

None

2.7 **Known Issues**

Disconnecting the power (VDD pin) of the Host MCU during the communication with OPTIGA™ Trust M and re-establishing the connection might end up in Infineon I2C protocol stack non responsive state due to the low level driver issue observed.

2.8 Limitations

- The maximum number of OPTIGA™ crypt instances which would be based on session is limited to 4 in parallel.
- 2. Third-party libraries such as mbed TLS might invoke memory allocation functions during optiga comms protection (shielded connection) operations (pal_crypt). There could be collision during memory allocation, if a create API from service layer is invoked at the same time.
- 3. OPTIGA™ is a singleton resource. The number of instances that can run in parallel is limited to 6 (1 active instance and 5 instances will be queued up internally). To increase the maximum number of parallel instances, re-configure the macro OPTIGA_CMD_MAX_REGISTRATIONS (minimum value is 1) in optiga_lib_config.h.
- 4. As the RSA key generation can go beyond 50 seconds, the default timeout of ifx i2c protocol (TL_MAX_EXIT_TIMEOUT) is set to 180 seconds. Otherwise, 10 seconds is sufficient.

Environment 2.9

None

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Document reference

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